



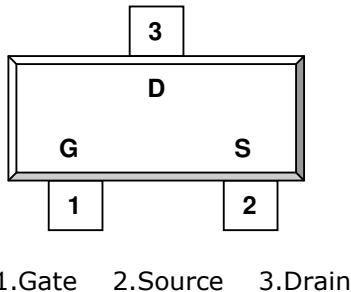
ST2342 
N Channel Enhancement Mode MOSFET

5.8A

DESCRIPTION

ST2342 is the N-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are required. The product is in a very small outline surface mount package.

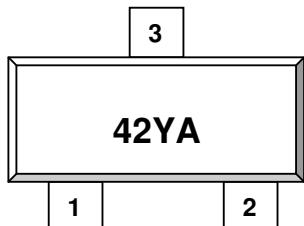
PIN CONFIGURATION SOT-23-3L



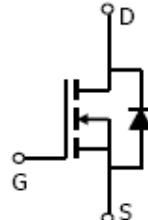
FEATURE

- 20V/5.8A, $R_{DS(ON)} = 26m\Omega$ (Typ.)
@ $V_{GS} = 4.5V$
- 20V/4.5A, $R_{DS(ON)} = 29m\Omega$
@ $V_{GS} = 2.5V$
- 20V/4.0A, $R_{DS(ON)} = 35m\Omega$
@ $V_{GS} = 1.8V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

PART MARKING SOT-23-3L



Y: Year Code A: Process Code





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ABSOLUTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current TJ=150°C	I _D	5.8 4.0	A
Pulsed Drain Current	I _{DM}	13	A
Continuous Source Current (Diode Conduction)	I _S	1.0	A
Power Dissipation	P _D	1.25 0.8	W
Operation Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	140	°C/W



ST2342 Pb
Lead-free

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ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	0.4		1.0	V
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V			1	uA
		V _{DS} =20V, V _{GS} =0V T _J =55°C			10	
Drain-source On-Resistance	R _{DSS(on)}	V _{GS} =4.5V, I _D =5.8A V _{GS} =2.5V, I _D =4.5A V _{GS} =1.8V, I _D =4.0A		0.026 0.029 0.035		Ω
Forward Transconductance	g _{fs}	V _{DS} =15V, I _D =4.8A		30		S
Diode Forward Voltage	V _{SD}	I _s =1.0A, V _{GS} =0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =10V V _{GS} =4.5V I _D =4.8A		10	13	nC
Gate-Source Charge	Q _{gs}			1.4		
Gate-Drain Charge	Q _{gd}			2.1		
Input Capacitance	C _{iss}	V _{DS} =10V V _{GS} =0V F=1MHz		600		pF
Output Capacitance	C _{oss}			120		
Reverse Transfer Capacitance	C _{rss}			100		
Turn-On Time	t _{d(on)} tr	V _{DD} =10V R _L =10Ω I _D =1.0A V _{GEN} =4.5V R _G =6Ω		15	25	nS
				40	60	
Turn-Off Time	t _{d(off)} tf			45	65	
				30	40	

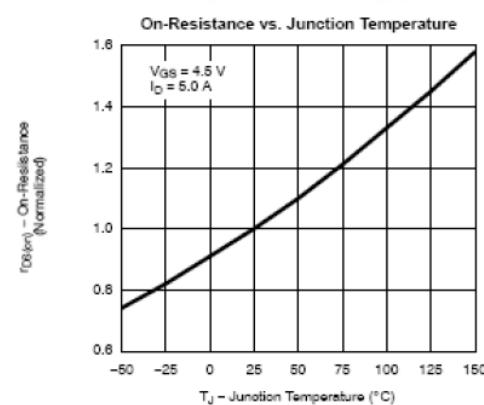
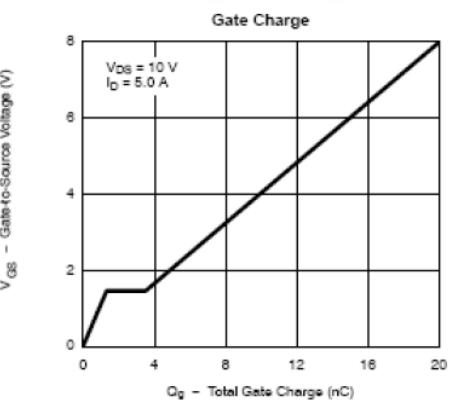
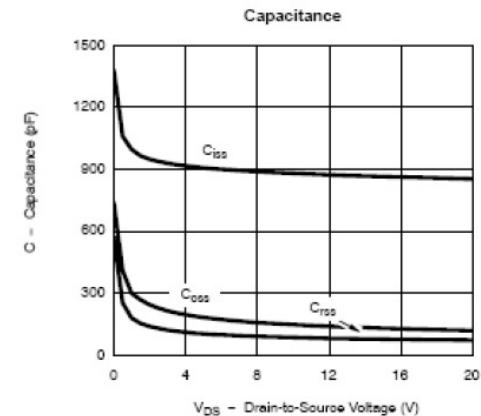
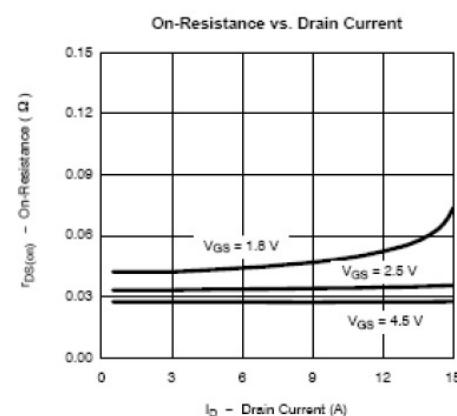
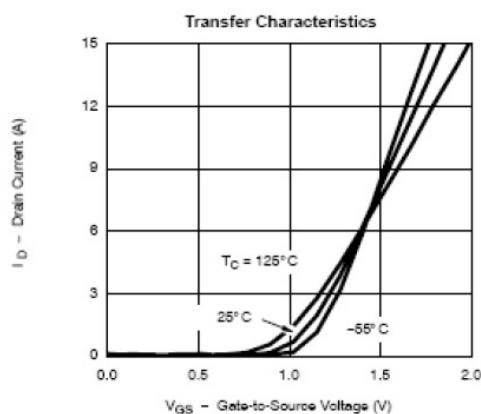
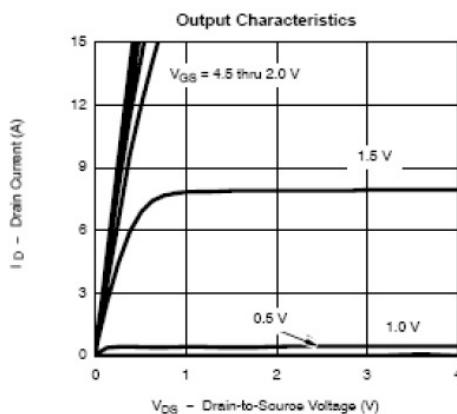


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TYPICAL CHARACTERISTICS (25°C Unless noted)



STANSON TECHNOLOGY
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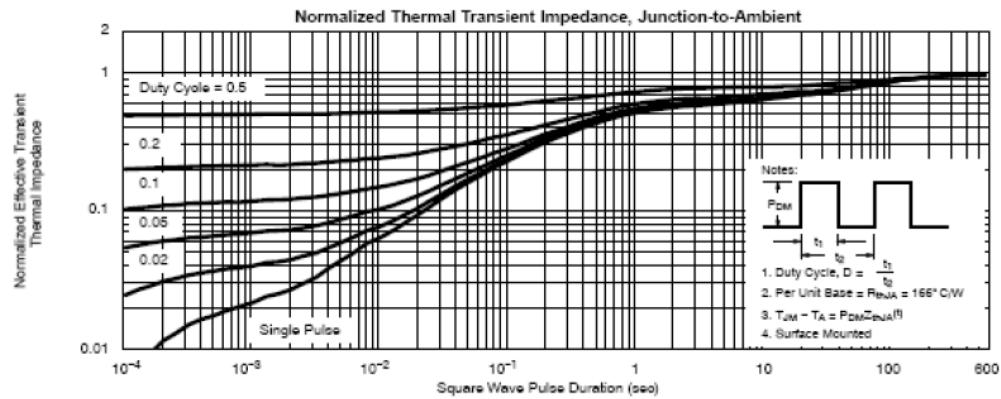
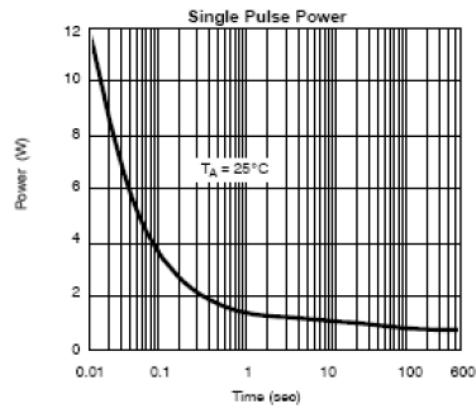
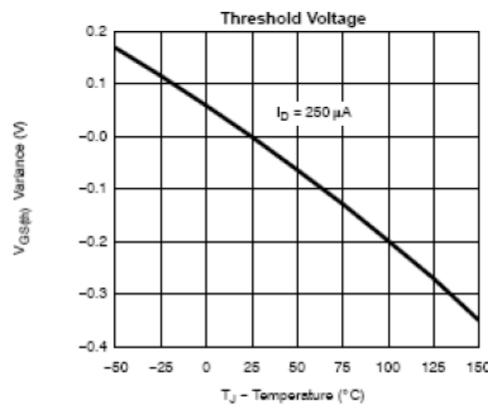
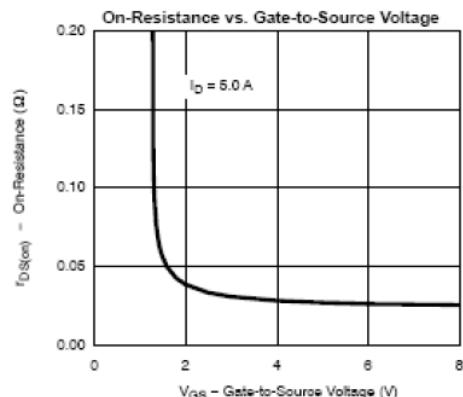
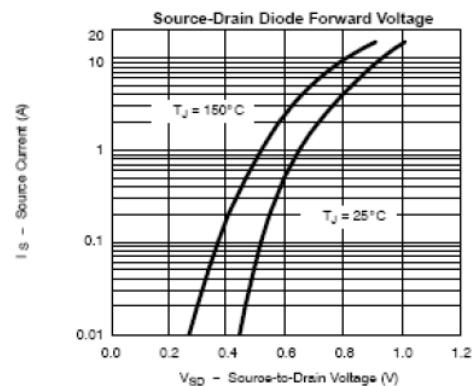
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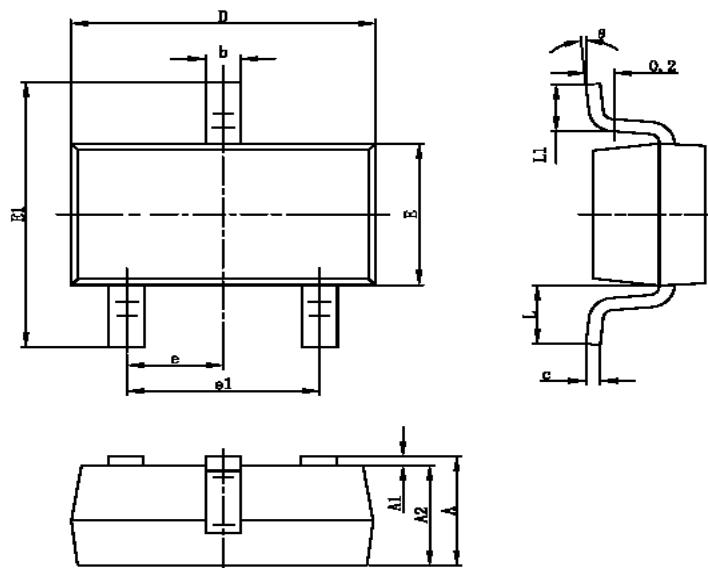




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SOT23-23L PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°